



# IMW120R045M1

CoolSiC<sup>™</sup> 1200V SiC Trench MOSFET Silicon Carbide MOSFET

#### Features

- Very low switching losses
- Threshold-free on state characteristic
- Wide gate-source voltage range
- Benchmark gate threshold voltage,  $V_{GS(th)} = 4.5V$
- 0V turn-off gate voltage
- Fully controllable dv/dt
- Commutation robust body diode, ready for synchronous rectification
- Temperature independent turn-off switching losses

#### **Benefits**

- Efficiency improvement
- Enabling higher frequency
- Increased power density
- Cooling effort reduction
- Reduction of system complexity and cost

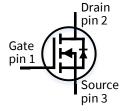
## **Potential applications**

- Energy generation
  - o Solar string inverter and solar optimizer
- Industrial power supplies
  - Industrial UPS
  - Industrial SMPS
- Infrastructure Charge
  - o Charger

## **Product validation**

Qualified for industrial applications according to the relevant tests of JEDEC 47/20/22

Table 1         Key Performance and Package Parameters									
Туре	V <sub>DS</sub>	I <sub>D</sub>	<b>R</b> <sub>DS(on)</sub>	<b>T</b> j,max	Marking	Package			
		$(T_{\rm C} = 25^{\circ}{\rm C}, R_{\rm th(j-c,max)})$	$(T_{vj} = 25^{\circ}C, I_{D} = 20A, V_{GS} = 15V)$						
IMW120R045M1	1200V	52A	45mΩ	175°C	120M1045	PG-TO247-3			











Datasheet
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**Maximum ratings** 

## **1** Maximum ratings

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

#### Table 2 Maximum ratings

Parameter	Symbol	Value	Unit
Drain-source voltage, $T_{vj} \ge 25^{\circ}$ C	V <sub>DSS</sub>	1200	V
DC drain current for $R_{th(j-c,max)}$ , limited by $T_{vjmax}$ , $V_{GS} = 15V$ ,			
<i>T</i> <sub>c</sub> = 25°C	I <sub>D</sub>	52	A
$T_{\rm C} = 100^{\circ}{\rm C}$		36	
Pulsed drain current, $t_p$ limited by $T_{vjmax}$ , $V_{GS} = 15V$	I <sub>D,pulse</sub> <sup>1</sup>	130	А
DC body diode forward current for $R_{th(j-c,max)}$ , limited by $T_{vjmax}$ , $V_{GS} = 0V$ $T_c = 25^{\circ}C$ $T_c = 100^{\circ}C$	I <sub>SD</sub>	52 28	A
Pulsed body diode current, $t_p$ limited by $T_{vjmax}$	I <sub>SD,pulse</sub> <sup>1</sup>	130	А
Gate-source voltage <sup>2</sup> Max transient voltage, < 1% duty cycle Recommended turn-on gate voltage Recommended turn-off gate voltage	V <sub>GSS</sub> V <sub>GSS,on</sub> V <sub>GSS,off</sub>	-10 20 15 0	V
Short-circuit withstand time $V_{DD} = 800V, V_{DS,peak} < 1200V, V_{GS,on} = 15V, T_{j,start} = 25^{\circ}C$	t <sub>sc</sub>	3	μs
Power dissipation, limited by $T_{vjmax}$ $T_c = 25^{\circ}C$ $T_c = 100^{\circ}C$	P <sub>tot</sub>	228 114	W
Virtual junction temperature	$T_{vj}$	-55175	°C
Storage temperature	T <sub>stg</sub>	-55150	°C
Soldering temperature, wavesoldering only allowed at leads, 1.6mm (0.063 in.) from case for 10 s	T <sub>sold</sub>	260	°C
Mounting torque, M3 screw Maximum of mounting processes: 3	М	0.6	Nm

<sup>1</sup> verified by design

<sup>2</sup> **Important note:** The selection of positive and negative gate-source voltages impacts the long-term behavior of the device. The design guidelines described in <u>Application Note AN2018-09</u> must be considered to ensure sound operation of the device over the planned lifetime.

Thermal resistances



## 2 Thermal resistances

#### Table 3

Davamatar	Symbol	Conditions	Value			Unit
Parameter	Symbol	Conditions	min.	typ.	max.	
MOSFET/body diode thermal resistance, junction – case	R <sub>th(j-c)</sub>		-	0.51	0.66	K/W
Thermal resistance, junction – ambient	$R_{ m th(j-a)}$	leaded	-	-	62	K/W

IMW120R045M1 CoolSiC<sup>™</sup> 1200V SiC Trench MOSFET Electrical Characteristics



## 3 Electrical Characteristics

### 3.1 Static characteristics

#### Table 4Static characteristics (at $T_{vj}$ = 25°C, unless otherwise specified)

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Drain-source on-state	$R_{\rm DS(on)}$	$V_{\rm GS} = 15 V, I_{\rm D} = 20 A,$				mΩ
resistance		<i>T</i> <sub>vj</sub> = 25°C	-	45	59	
		<i>T</i> <sub>vj</sub> = 100°C	-	55	-	
		<i>T</i> <sub>νj</sub> = 175°C	-	75	-	
Body diode forward	$V_{\rm SD}$	$V_{\rm GS} = 0$ V, $I_{\rm SD} = 20$ A				V
voltage		<i>T</i> <sub>vj</sub> = 25°C	-	4.1	5.2	
		<i>T</i> <sub>vj</sub> = 100°C	-	4.0	-	
		<i>T</i> <sub>νj</sub> = 175°C	-	3.9	-	
Gate-source threshold	$V_{\rm GS(th)}$	(tested after 1 ms pulse at				V
voltage		$V_{\rm GS} = 20 \text{V}$				
		$I_{\rm D} = 10 {\rm mA}, V_{\rm DS} = V_{\rm GS}$				
		<i>T</i> <sub>vj</sub> = 25°C	3.5	4.5	5.7	
		T <sub>vj</sub> =175°C	-	3.6	-	
Zero gate voltage drain	I <sub>DSS</sub>	$V_{\rm GS} = 0$ V, $V_{\rm DS} = 1200$ V				μΑ
current		T <sub>vj</sub> =25°C	-	2	200	
		<i>T</i> <sub>vj</sub> =175°C	-	4	-	
Gate-source leakage	I <sub>GSS</sub>	$V_{\rm GS} = 20 V, V_{\rm DS} = 0 V$	-	-	120	nA
current		$V_{\rm GS} = -10 V, V_{\rm DS} = 0 V$	-	-	-120	nA
Transconductance	$g_{fs}$	$V_{\rm DS} = 20V, I_{\rm D} = 20A$	-	11.1	-	S
Internal gate resistance	<b>R</b> <sub>G,int</sub>	$f = 1$ MHz, $V_{AC} = 25$ mV	-	4	-	Ω

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**Electrical Characteristics** 

## 3.2 Dynamic characteristics

## Table 5Dynamic characteristics (at $T_{vj} = 25^{\circ}$ C, unless otherwise specified)

Parameter	Complex	Symbol Conditions	Value			11
	Symbol		min.	typ.	max.	— Unit
Input capacitance	Ciss		-	1900	-	
Output capacitance	Coss	$V_{\rm DD} = 800 V, V_{\rm GS} = 0 V,$	-	115	-	рF
Reverse capacitance	Crss	<i>f</i> = 1MHz, <i>V</i> <sub>AC</sub> = 25mV	-	13	-	
Coss stored energy	E <sub>oss</sub>		-	44	-	μJ
Total gate charge	Q <sub>G</sub>		-	52	-	
Gate to source charge	$Q_{\rm GS,pl}$	$V_{DD} = 800V, I_{D} = 20A,$ $V_{GS} = 0/15V, turn-on pulse$	-	15	-	nC
Gate to drain charge	$Q_{\rm GD}$	$v_{GS} = 0/15v$ , turn-on pulse	-	13	-	

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**Electrical Characteristics** 



## 3.3 Switching characteristics

#### Table 6Switching characteristics, Inductive load 4

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>MOSFET Characteristics</b> ,	<i>T</i> <sub>vj</sub> = 25°C					
Turn-on delay time	$t_{ m d(on)}$	$V_{\rm DD} = 800 \text{V}, I_{\rm D} = 20 \text{A},$	-	9	-	ns
Rise time	tr	$V_{\rm GS} = 0/15 V, R_{\rm G,ext} = 2\Omega,$	-	24	-	
Turn-off delay time	$t_{ m d(off)}$	$L_{\sigma}$ = 40nH,	-	17	-	
Fall time	t <sub>f</sub>	diode: body diode at V <sub>GS</sub> = 0V	-	13	-	
Turn-on energy	Eon		-	350	-	μJ
Turn-off energy	E <sub>off</sub>	see Fig. E	-	70	-	
Total switching energy	E <sub>tot</sub>		-	420	-	
Body Diode Characteristi	cs, $T_{vj} = 25^{\circ}C$					
Diode reverse recovery charge	Qrr	$V_{DD} = 800V, I_{SD} = 20A,$ $V_{GS}$ at diode = 0V,	-	0.15	-	μC
Diode peak reverse recovery current	I <sub>rrm</sub>	d <i>i</i> <sub>f</sub> /d <i>t</i> = 1000A/μs, Q <sub>rr</sub> includes also Q <sub>c</sub> , see Fig. C	-	8	-	A

MOSFET Characteristics,	$T_{vj} = 175^{\circ}C$					
Turn-on delay time	$t_{\rm d(on)}$	$V_{\rm DD} = 800 \text{V}, I_{\rm D} = 20 \text{A},$	-	9	-	ns
Rise time	tr	$V_{\rm GS} = 0/15 V, R_{\rm G,ext} = 2 \Omega,$	-	24	-	
Turn-off delay time	$t_{ m d(off)}$	$L_{\sigma}$ = 40nH,	-	20	-	
Fall time	t <sub>f</sub>	diode: body diode at V <sub>GS</sub> = 0V see Fig. E	-	14	-	
Turn-on energy	$E_{on}$		-	380	-	μJ
Turn-off energy	$E_{\rm off}$		-	75	-	
Total switching energy	$E_{\rm tot}$		-	455	-	
Body Diode Characteristi	cs, $T_{vj} = 17$	5°C				
Diode reverse recovery charge	Q <sub>rr</sub>	$V_{DD} = 800V, I_{SD} = 20A,$ $V_{GS}$ at diode = 0V,	-	0.25	-	μC
Diode peak reverse recovery current	<i>I</i> <sub>rrm</sub>	di <sub>f</sub> /dt = 1000A/μs, Q <sub>rr</sub> includes also Q <sub>c</sub> , see Fig. C	-	10	-	A

 $^4$  The chip technology was characterized up to 200 kV/µs. The measured dV/dt was limited by measurement test setup and package.

4



## Electrical characteristic diagrams

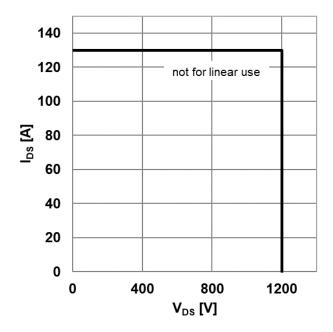


Figure 1 Reverse bias safe operating area (RBSOA) ( $V_{gs} = 0/15V$ ,  $T_c = 25^{\circ}C$ ,  $T_j < 175^{\circ}C$ )

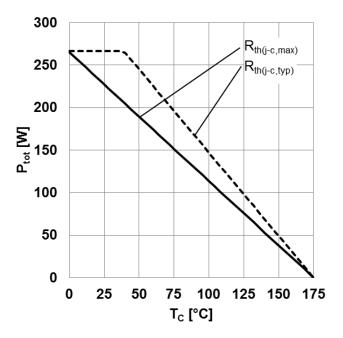
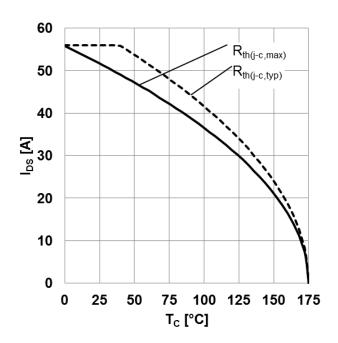


Figure 2 Power dissipation as a function of case temperature limited by bond wire  $(P_{tot} = f(T_c))$ 



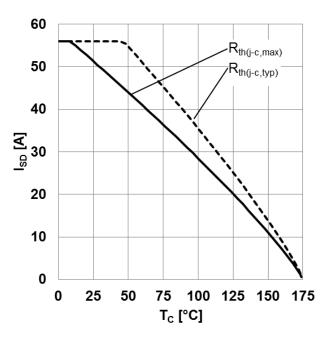
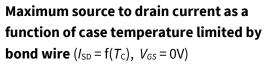
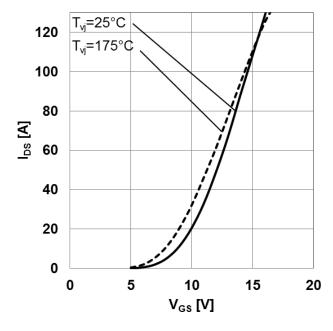
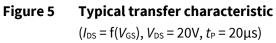


Figure 3 Maximum DC drain to source current as a Figure 4 function of case temperature limited by bond wire  $(I_{DS} = f(T_C))$ 









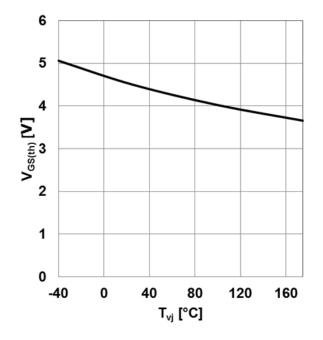


Figure 6 Typical gate-source threshold voltage as a function of junction temperature  $(V_{GS(th)} = f(T_{vj}), I_{DS} = 10 \text{ mA}, V_{GS} = V_{DS})$ 

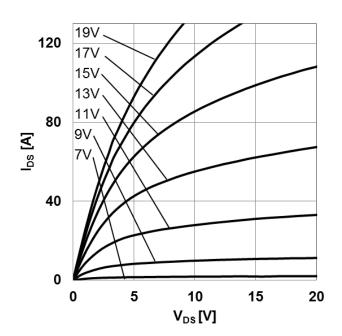


Figure 7 Typical output characteristic,  $V_{GS}$  as parameter ( $I_{DS} = f(V_{DS}), T_{vj}=25^{\circ}C, t_{P} = 20\mu s$ )

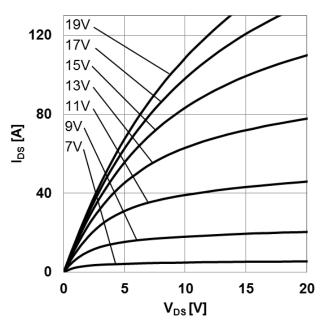
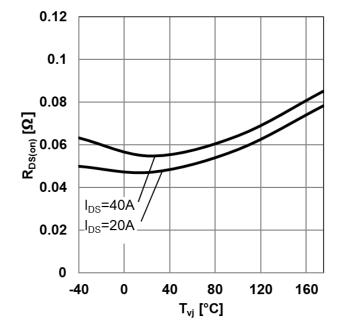
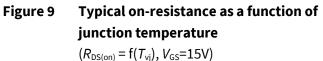
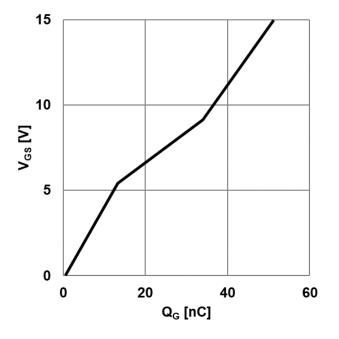


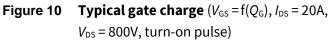
Figure 8 Typical output characteristic,  $V_{GS}$  as parameter ( $I_{DS} = f(V_{DS})$ ,  $T_{vj}=175^{\circ}C$ ,  $t_{P} = 20\mu s$ )

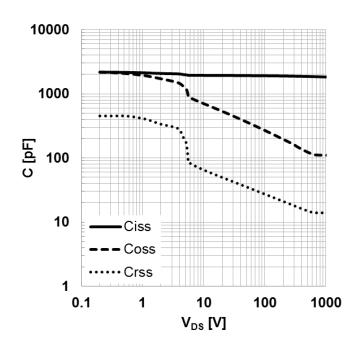


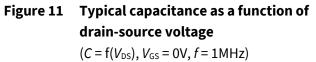












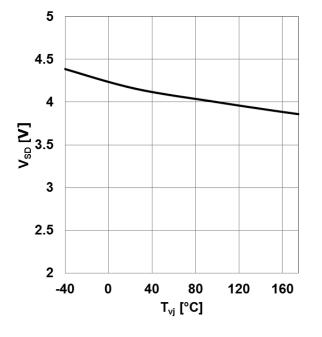


Figure 12 Typical body diode forward voltage as function of junction temperature  $(V_{SD}=f(T_{vj}), V_{GS}=0V, I_{SD}=20A)$ 



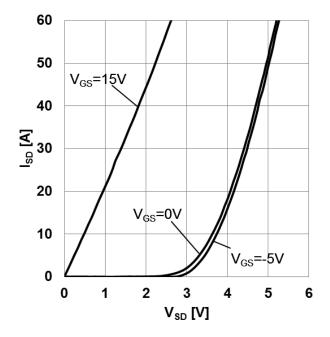
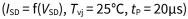


Figure 13 Typical body diode forward current as function of forward voltage, V<sub>GS</sub> as parameter



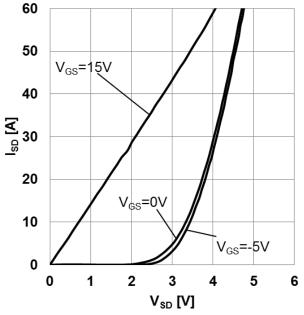
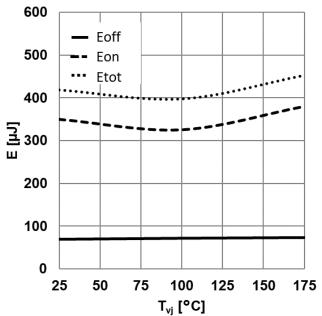


Figure 14 Typical body diode forward current as function of forward voltage,  $V_{GS}$  as parameter  $(I_{SD} = f(V_{SD}), T_{vj} = 175^{\circ}C, t_{P} = 20\mu s)$ 



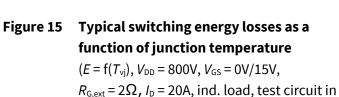


Fig. E, diode: body diode)

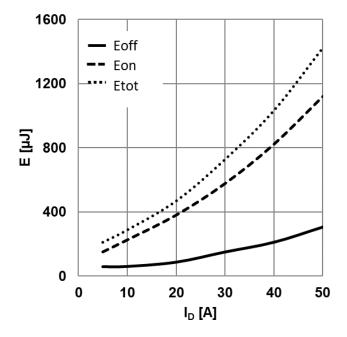
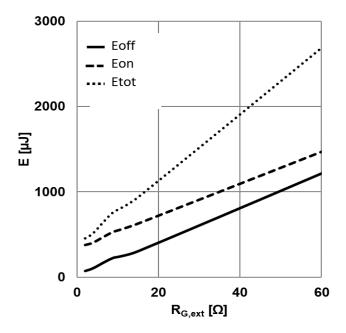
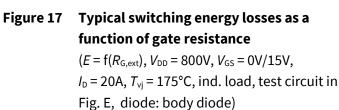


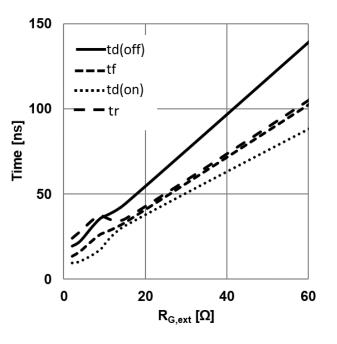
Figure 16 Typical switching energy losses as a function of drain-source current

 $(E = f(I_{DS}), V_{DD} = 800V, V_{GS} = 0V/15V,$  $R_{G,ext} = 2\Omega, T_{vj} = 175^{\circ}C$ , ind. load, test circuit in Fig. E, diode: body diode)



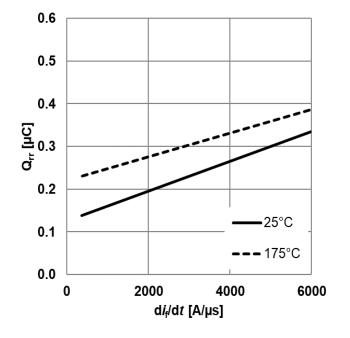








 $(t = f(R_{G,ext}), V_{DD} = 800V, V_{GS} = 0V/15V, I_D = 20A, T_{vj} = 175^{\circ}C$ , ind. load, test circuit in Fig. E, diode: body diode)



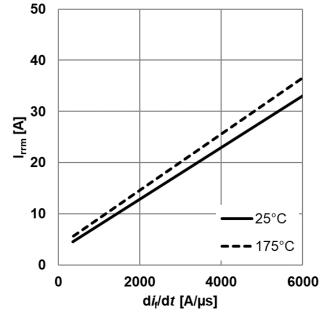


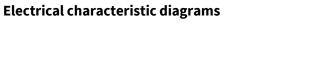
Figure 19 Typical reverse recovery charge as a function of diode current slope  $(Q_{rr} = f(di_f/dt), V_{DD} = 800V, I_D = 20A, ind. load,$ 

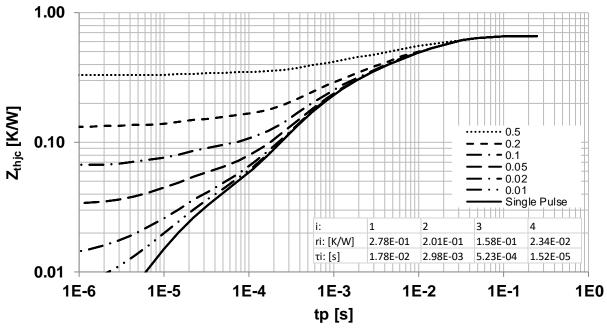
test circuit in Fig.E)

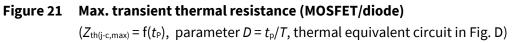
Figure 20 Typical reverse recovery current as a function of diode current slope

 $(I_{rrm} = f(di_f/dt), V_{DD} = 800V, I_D = 20A, ind. load, test circuit in Fig.E)$ 









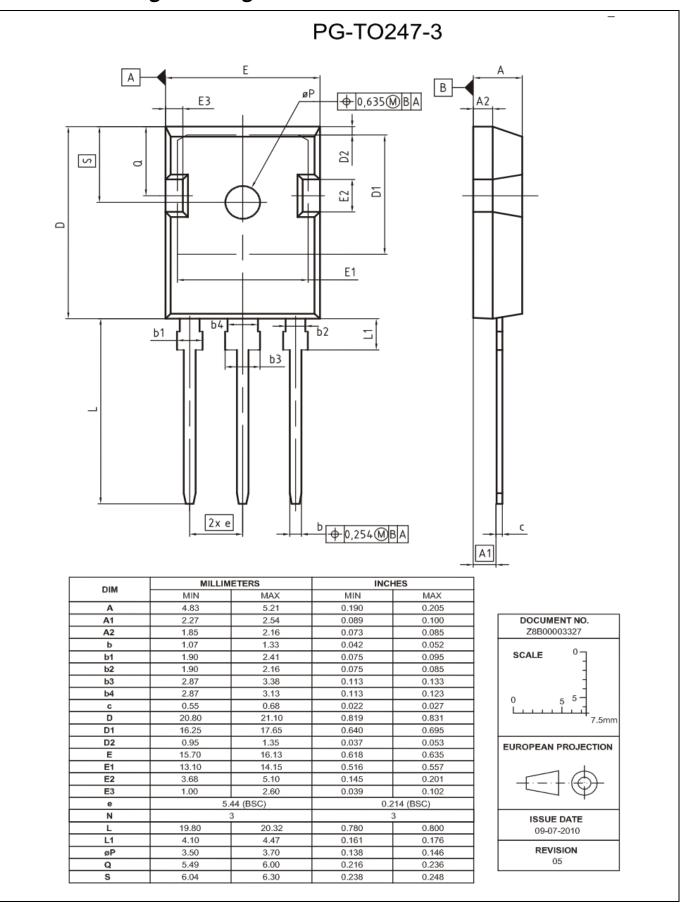
#### IMW120R045M1

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Package drawing







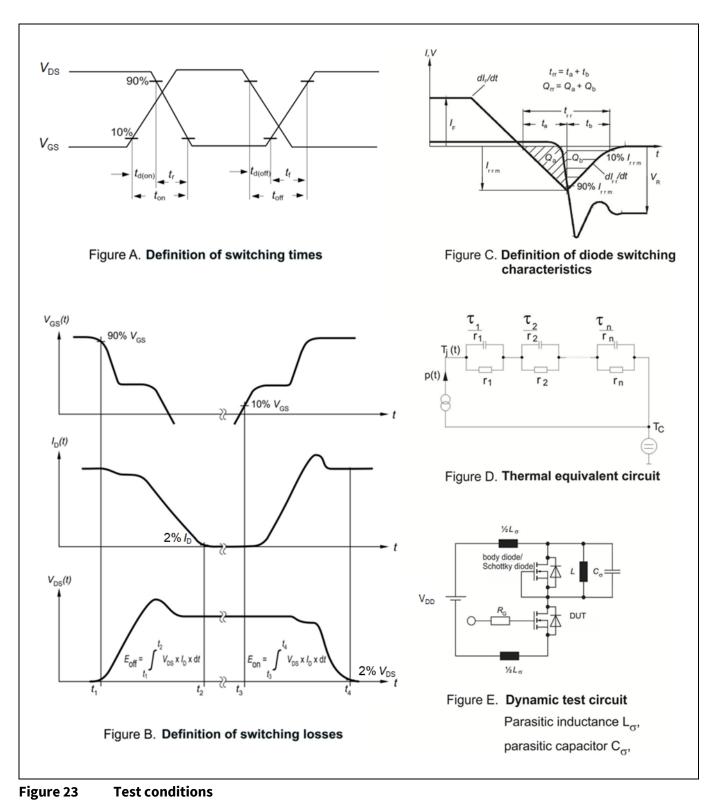
#### Figure 22 Package drawing

### IMW120R045M1 CoolSiC<sup>™</sup> 1200V SiC Trench MOSFET

**Test conditions** 



6 Test conditions





## **Revision history**

#### Major changes since the last revision

Document version	Date of release	Description of changes
2.1	2018-03-01	Initial version
2.2	2018-05-30	Important footnote update in chapter 1
		Change of conditions for switching dynamic characteristics in chapter 3.2 and 3.3
		Additional figures for V <sub>GS</sub> =0V/15V in chapter 4
2.3	2019-04-18	Add Recommended gate voltage in chapter 1
		Add SOA figure in chapter 4
		Figures removed for V <sub>GS</sub> =-5V/15V in chapter 4
2.4	2019-12-10	Move the short circuit time from dynamic characteristics table 5 to maximum ratings table 2.
		Update the Figure 21 Zth curve.
2.5	2020-06-12	Correction of marking letters in table 1
2.6	2020-12-11	Correction of circuit symbol on page 1

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